DOCKET NO.: 261137US26YA PCT/sal

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF:

Lee CHEN, et al. GROUP: 1763

SERIAL NO: 10/517,764

FILED: December 23, 2004 EXAMINER: OLSEN, ALLAN W

FOR: ANISOTROPIC DRY ETCHING OF CU-CONTAINING LAYERS

SUBMISSION OF SUPPLEMENTAL APPLICATION DATA SHEET

Office of Initial Patent Examination Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

Applicant(s) submit herewith a Supplemental Application Data Sheet for the above-identified application for the purpose of correcting the 1st inventor's city of residence and his mailing address.

Respectfully Submitted,

OBLON, SPIVAK, McCLELLAND, MAIER & NEUSTADT, P.C.

Steven P. Weihrouch

Registration No. 32,829 Joseph Scafetta, Jr.

Registration No. 26,803

Customer Number

22850

Tel. (703) 413-3000 Fax. (703) 413-2220 (OSMMN 06/04)